TMBF410A

SINGLE PHASE4.0AMPS. GLASS PASSIVATED BRIDGE RECTIFIERS

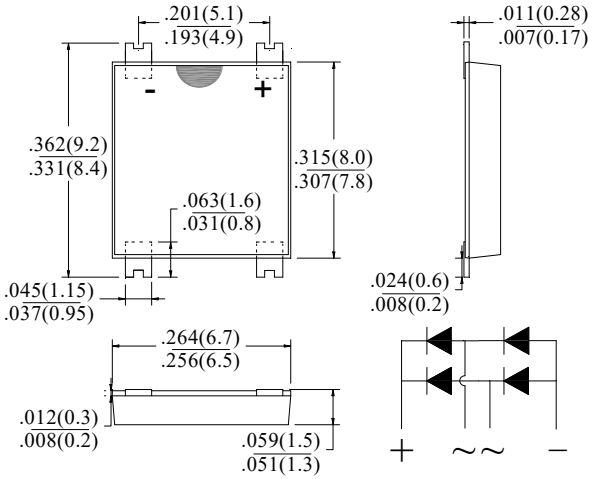
FEATURE

. Glass passivated junction.
. Ideal for printed circuit board.
. Reliable low cost construction utilizing molded plastic technique.
. High surge current capability.
. High temperature soldering guaranteed: 260℃/10 seconds at terminals.

MECHANICAL DATA

. Case Material: "Green" Molding compound, UL flammability classification rating 94V-0, "Halogen free"
. Moisture sensitivity level:level 2a,per J-STD-020
. Polarity:Polarity as marked on the body
. Weight: 0.204g (approximately)

TMBF



Dimensions in inches and (millimeters)

Single phase, half wave, 60Hz,resistive or inductive load. For capacitive load, derate current by 20%

MAXIMUM RATINGS (T_C=25℃ unless otherwise noted)

Parameter	SYMBOL Marking	TMBF410A TMBF410A	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1000	V
Maximum RMS Voltage	V_{RMS}	700	V
Maximum DC blocking Voltage	V_{DC}	1000	V
Average Forward Rectified Current	$I_{F(AV)}$	4.0	A
Non-repetitive forward surge current,8.3mS half sine-wave	I_{FSM}	100	A
I^2t Rating for Fusing(t < 8.3ms)	I^2t	41.5	A^2Sec
Typical Junction Capacitance (Note 1)	C_J	50	pF
Operation Junction and Storage Temperature	T_J, T_{STG}	-55 to + 150	°C

ELECTRICAL CHARACTERISTICS (T_C=25℃ unless otherwise noted)

Parameter		SYMBOL	Min	Typ	Max	Units
Reverse Breakdown Voltage at Ir=0.01mA		V_{BR}	1000	-----	-----	V
Instantaneous Forward	@IF=2.0A	V_F	-----	0.91	1.0	V
voltage at T_J=25°C	@ IF=4.0A		-----	0.96	1.1	
reverse current	@T_J=25°C	I_R	-----	-----	5.0	uA
at rated DC blocking voltage	@T_J=125°C		-----	-----	100.0	

THERMAL CHARACTERISTICS(T_C=25℃ unless otherwise noted)

Parameter	SYMBOL	TMBF410A	Units
Typical Thermal Resistance (Note 3)	$R_{(JA)}$ $R_{(JC)}$	75 10	°C /W

Note:

1.Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc

2.Measured on P.C.Board with15.0mm*15.0mm*1.6mm Copper Pad Areas

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

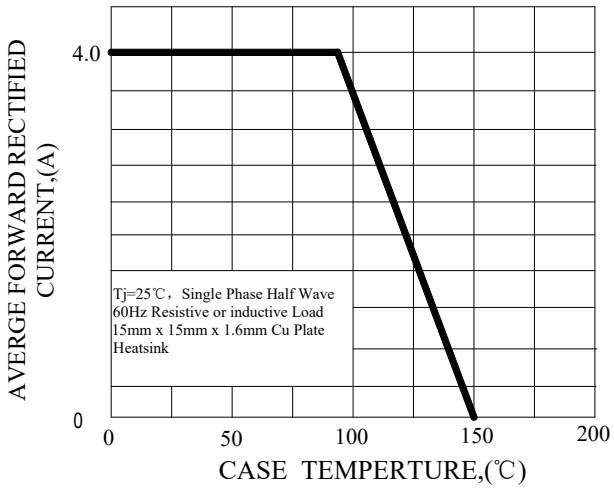


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

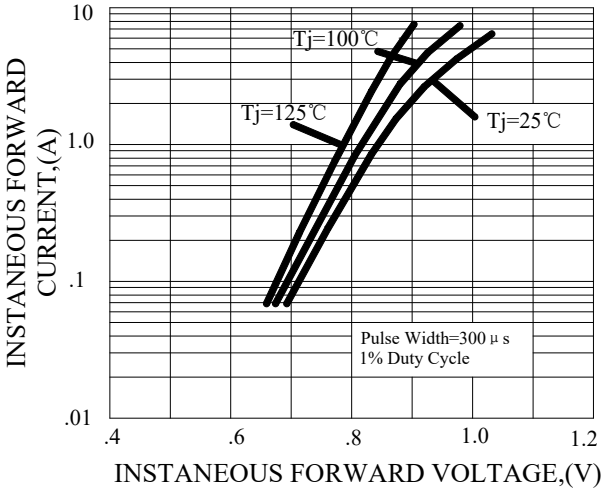


FIG.3-MAXIMUN NON-REPETITIVE FORWARD SURGE CURRENT

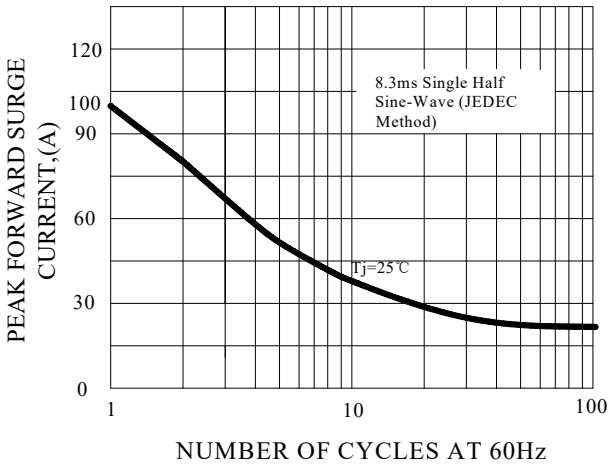


FIG.4-TYPICAL REVERSE CHARACTERISTICS

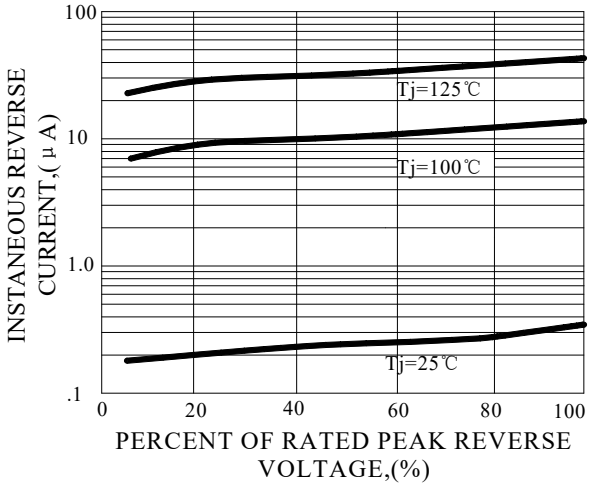
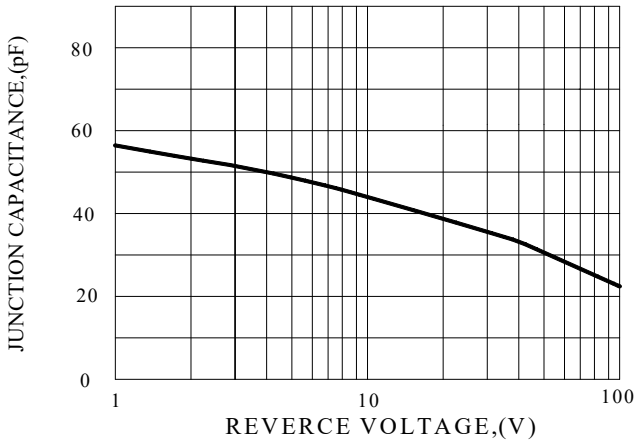
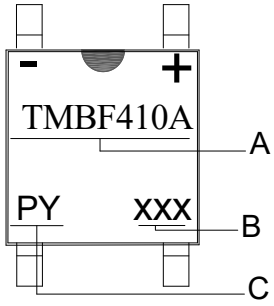


FIG.6-TYPIAL JUNCTION CAPACITANCE



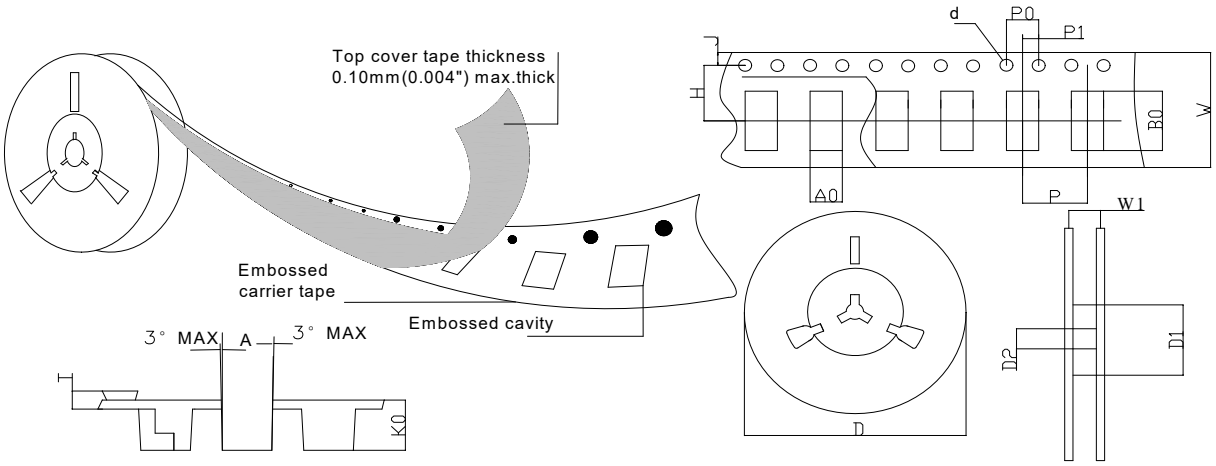
Marking and packaging illustration

1、Marking



SYMBOL	Explanation
A	Product Name
B	Date Code
C	Trademark

2、Packaging



SPECIFICATIONS mm(inch)		PACKAGE	SPECIFICATIONS mm(inch)		PACKAGE
ITEM	SYM BOL	TMBF	ITEM	SYM BOL	TMBF
Carrier width	A	7.0(0.276)Max	Carrier depth	K	1.70(0.067)Typ
Carrier length	B	9.9(0.390)Max	Punch hole pitch	P	12.00(0.472)Typ
Sprocket hole	d	ø1.55(0.061)Typ	Sprocket hole pitch	P0	4.00(0.157)Typ
Reel outer diameter	D	330.0(13.0)Typ	Embossment center	P1	2.00(0.079)Typ
Reel inner diameter	D1	50.0(1.969)Min	Overall tape thickness	T	0.33(0.013)Typ
Feed hole diameter	D2	13.0(0.512)Typ	Tape width	W	16.0(0.630)Typ
Sprocket hole position	J	1.75(0.069)Typ	Reel width	W1	12.4(0.488)Min
Punch hole position	H	7.50(0.295)Typ			